

## **Description**

The 2SK4178-ZK-E1-AY uses advanced trench technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = 30V I_{D} = 60 A$ 

 $R_{DS(ON)} < 9m\Omega @ V_{GS}=10V$ 

## **Application**

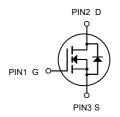
**Battery protection** 

Load switch

Uninterruptible power supply



TO-252-2L (DPAK)



N-Channel MOSFET

## **Package Marking and Ordering Information**

| Product ID       | Pack            | Brand      | Qty(PCS) |
|------------------|-----------------|------------|----------|
| 2SK4178-ZK-E1-AY | TO-252-2L(DPAK) | HXY MOSFET | 2500     |

### Absolute Maximum Ratings (Tc=25°C unless otherwise specified)

| Symbol                                | Parameter   | Rating  | Units |  |
|---------------------------------------|---|---|-------|--|
| V <sub>D</sub> s                      | Drain-Source Voltage  | 30  | V     |  |
| Vgs                                   | Gate-Source Voltage   | ±20   | V     |  |
| I <sub>D</sub> @T <sub>C</sub> =25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>    | 60  | А     |  |
| I <sub>D</sub> @T <sub>C</sub> =100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>    | 40  | А     |  |
| I <sub>D</sub> @T <sub>A</sub> =25°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>    | 13.6  | А     |  |
| I <sub>D</sub> @T <sub>A</sub> =70°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>    | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> 11.4 |       |  |
| Ідм                                   | Pulsed Drain Current <sup>2</sup>                               | 110   | А     |  |
| EAS                                   | Single Pulse Avalanche Energy <sup>3</sup>                      | gle Pulse Avalanche Energy³ 57.8                                  |       |  |
| las                                   | Avalanche Current   | 34  |       |  |
| P <sub>D</sub> @T <sub>C</sub> =25°C  | Total Power Dissipation <sup>4</sup>                            | 41  | W     |  |
| P <sub>D</sub> @T <sub>A</sub> =25°C  | Total Power Dissipation <sup>4</sup>                            | 2.42  | W     |  |
| Тѕтс                                  | Storage Temperature Range                                       | -55 to 175  | °C    |  |
| TJ                                    | Operating Junction Temperature Range                            | -55 to 175  | °C    |  |
| Reja                                  | Thermal Resistance Junction-ambient (Steady State) <sup>1</sup> | 62  | °C/W  |  |
| Rejc                                  | Thermal Resistance Junction-Case <sup>1</sup>                   | 3.6   | °C/W  |  |



### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

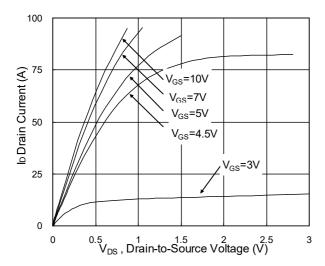
| Symbol                 | Parameter                                      | Conditions   | Min. | Тур.  | Max. | Unit  |
|------------------------|--|--|------|-------|------|-------|
| BVDSS                  | Drain-Source Breakdown Voltage                 | V <sub>GS</sub> =0V , I <sub>D</sub> =250uA                        | 30   |       |      | V     |
| △BVdss/△TJ             | BVDSS Temperature Coefficient                  | Reference to 25°C, I <sub>D</sub> =1mA                             |      | 0.027 |      | V/°C  |
|                        |  | V <sub>GS</sub> =10V , I <sub>D</sub> =30A                         |      | 7     | 9    |       |
| RDS(ON)                | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A                        |      | 11    | 14   | mΩ    |
| V <sub>GS(th)</sub>    | Gate Threshold Voltage                         |  | 1.2  | 1.5   | 2.5  | V     |
| $\triangle V_{GS(th)}$ | V <sub>GS(th)</sub> Temperature Coefficient    | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA           |      | -5.8  |      | mV/°C |
| 1                      | Dunin Course Lookers Current                   | V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C  |      |       | 1    |       |
| IDSS                   | Drain-Source Leakage Current                   | V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C  |      |       | 5    | uA    |
| Igss                   | Gate-Source Leakage Current                    | V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V                        |      |       | ±100 | nA    |
| gfs                    | Forward Transconductance                       | V <sub>DS</sub> =5V , I <sub>D</sub> =30A                          |      | 38    |      | S     |
| Rg                     | Gate Resistance                                | V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz                 |      | 2.2   | 3.5  |       |
| Qg                     | Total Gate Charge (4.5V)                       |  |      | 12.6  | 17.6 |       |
| Qgs                    | Gate-Source Charge                             | V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =15A |      | 4.2   | 5.9  | nC    |
| Q <sub>gd</sub>        | Gate-Drain Charge                              |  |      | 5.1   | 7.1  |       |
| T <sub>d(on)</sub>     | Turn-On Delay Time                             |  |      | 4.6   | 9.2  |       |
| Tr                     | Rise Time                                      | V <sub>DD</sub> =15V , V <sub>GS</sub> =10V , R <sub>G</sub> =3.3  |      | 12.2  | 22   |       |
| Td(off)                | Turn-Off Delay Time                            | I <sub>D</sub> =15A  |      | 26.6  | 53   | ns    |
| T <sub>f</sub>         | Fall Time                                      |  |      | 8     | 16   |       |
| Ciss                   | Input Capacitance                              |  |      | 1317  | 1843 |       |
| Coss                   | Output Capacitance                             | V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz                |      | 163   | 228  | pF    |
| Crss                   | Reverse Transfer Capacitance                   |  |      | 131   | 183  |       |
| Is                     | Continuous Source Current <sup>1,5</sup>       |  |      |       | 55   | Α     |
| Ism                    | Pulsed Source Current <sup>2,5</sup>           | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current                 |      |       | 110  | Α     |
| VsD                    | Diode Forward Voltage <sup>2</sup>             | V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C    |      |       | 1.2  | V     |
| t <sub>rr</sub>        | Reverse Recovery Time                          | IF=30A, dl/dt=100A/µs,   |      | 9.2   |      | nS    |
| Qrr                    | Reverse Recovery Charge                        |  |      | 2     |      | nC    |

#### Note:

- 1 .The data tested by surface mounted on a 1 inch  $^2$  FR-4 board with 2OZ copper. 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3.The EAS data shows Max. rating . The test condition is VDD=25V,VGS=10V,L=0.1mH,IAS=34A
- 4.The power dissipation is limited by 175°C junction temperature
- 5.The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

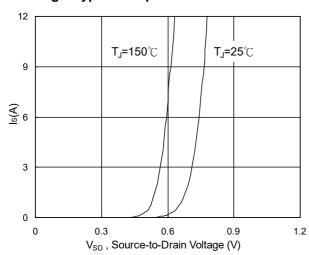


Fig.3 Forward Characteristics of Reverse

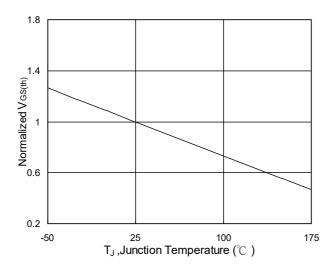


Fig.5 Normalized V<sub>GS(th)</sub> vs. T<sub>J</sub>

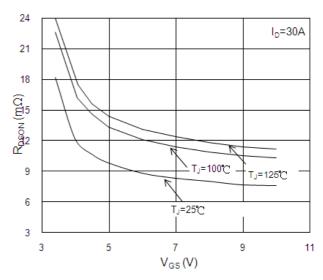


Fig.2 On-Resistance vs. G-S Voltage

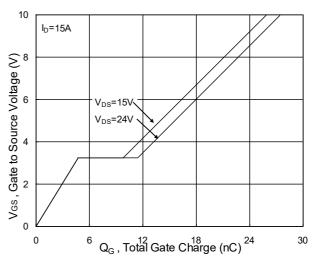


Fig.4 Gate-Charge Characteristics

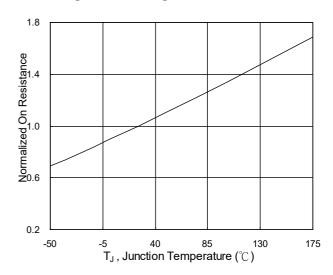
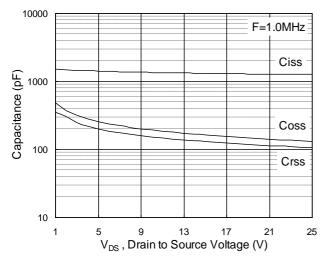


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>



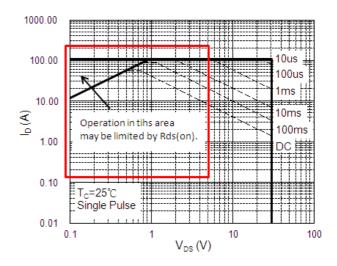


Fig.7 Capacitance

Fig.8 Safe Operating Area

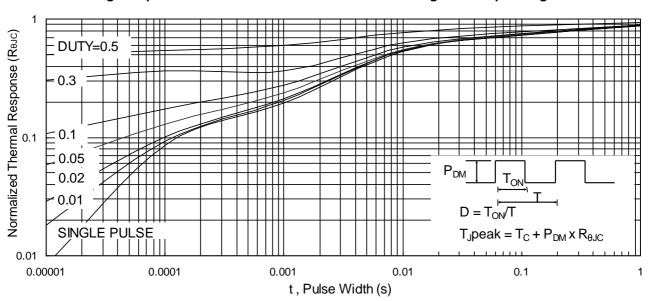
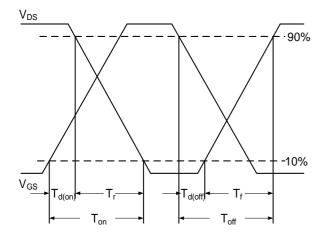
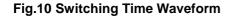


Fig.9 Normalized Maximum Transient Thermal Impedance





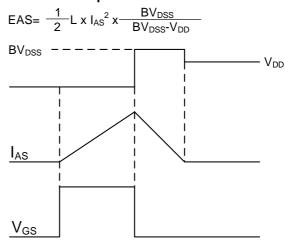
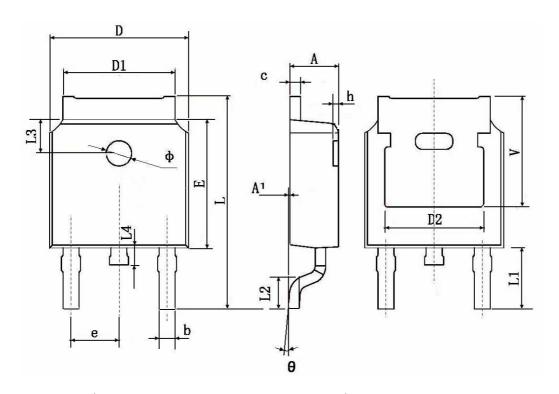


Fig.11 Unclamped Inductive Switching Waveform



# TO-252-2L(DPAK) Package Information



| Symbol | Dimensions In Millimeters |        | Dimensions In Inches |       |  |
|--------|---------------------------|--------|----------------------|-------|--|
|        | Min.                      | Max.   | Min.                 | Max.  |  |
| Α      | 2.200                     | 2.400  | 0.087                | 0.094 |  |
| A1     | 0.000                     | 0.127  | 0.000                | 0.005 |  |
| b      | 0.660                     | 0.860  | 0.026                | 0.034 |  |
| С      | 0.460                     | 0.580  | 0.018                | 0.023 |  |
| D      | 6.500                     | 6.700  | 0.256                | 0.264 |  |
| D1     | 5.100                     | 5.460  | 0.201                | 0.215 |  |
| D2     | 0.483 TYP.                |        | 0.190 TYP.           |       |  |
| E      | 6.000                     | 6.200  | 0.236                | 0.244 |  |
| е      | 2.186                     | 2.386  | 0.086                | 0.094 |  |
| L      | 9.800                     | 10.400 | 0.386                | 0.409 |  |
| L1     | 2.900 TYP.                |        | 0.114 TYP.           |       |  |
| L2     | 1.400                     | 1.700  | 0.055                | 0.067 |  |
| L3     | 1.600 TYP.                |        | 0.063 TYP.           |       |  |
| L4     | 0.600                     | 1.000  | 0.024                | 0.039 |  |
| Ф      | 1.100                     | 1.300  | 0.043                | 0.051 |  |
| θ      | 0°                        | 8°     | 0°                   | 8°    |  |
| h      | 0.000                     | 0.300  | 0.000                | 0.012 |  |
| V      | 5.350 TYP. 0.211 TYP.     |        | TYP.                 |       |  |



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